

May 2010

# **KSC5305D NPN Silicon Transistor**

### **Features**

- High Voltage High Speed Power Switch Application
- · Built-in Free-wheeling Diode makes efficient anti saturation operation
- Suitable for half bridge light ballast Applications
- No need to interest an h<sub>FE</sub> value because of low variable storage-time spread even though corner spirit product
- Low base drive requirement



### **Absolute Maximum Ratings** T<sub>a</sub> = 25°C unless otherwise noted

| Symbol           | Parameter                                | Value       | Units |
|------------------|--|-------------|-------|
| V <sub>CBO</sub> | Collector Base Voltage                   | 800         | V     |
| V <sub>CEO</sub> | Collector Emitter Voltage                | 400         | V     |
| V <sub>EBO</sub> | Emitter Base Voltage                     | 12          | V     |
| I <sub>C</sub>   | Collector Current (DC)                   | 5           | Α     |
| I <sub>CP</sub>  | *Collector Current (Pulse)               | 10          | Α     |
| I <sub>B</sub>   | Base Current (DC)                        | 2           | Α     |
| I <sub>BP</sub>  | *Base Current (Pulse)                    | 4           | Α     |
| P <sub>C</sub>   | Power Dissipation (T <sub>C</sub> =25°C) | 75          | W     |
| TJ               | Junction Temperature                     | 150         | °C    |
| T <sub>STG</sub> | Storage Temperature                      | - 65 to 150 | °C    |

<sup>\*</sup> Pulse Test : Pulse Width = 5mS, Duty cycles \le 10%

### **Thermal Characteristics**

| Symbol        | Parameter          |                     | Rating | Units |
|---------------|--------------------|---------------------|--------|-------|
| $R_{	hetajc}$ | Thermal Resistance | Junction to Case    | 1.65   | °C/W  |
| $R_{	hetaja}$ |                    | Junction to Ambient | 62.5   | °C/W  |

# **Electrical Characteristics** $T_a$ =25°C unless otherwise noted

| Symbol                               | Parameter                            | Test Condition  | Min.    | Тур.       | Max.       | Units    |
|--------------------------------------|--------------------------------------|---|---------|------------|------------|----------|
| BV <sub>CBO</sub>                    | Collector-Base Breakdown Voltage     | I <sub>C</sub> =1mA, I <sub>E</sub> =0  | 800     | -          | -          | V        |
| BV <sub>CEO</sub>                    | Collector-Emitter Breakdown Voltage  | I <sub>C</sub> =5mA, I <sub>B</sub> =0  | 400     | -          | -          | V        |
| BV <sub>EBO</sub>                    | Emitter-Base Breakdown Voltage       | I <sub>E</sub> =1mA, I <sub>C</sub> =0  | 12      | -          | -          | V        |
| I <sub>CBO</sub>                     | Collector Cut-off Current            | V <sub>CB</sub> =500V, I <sub>E</sub> =0  | -       | -          | 10         | μΑ       |
| I <sub>EBO</sub>                     | Emitter Cut-off Current              | V <sub>EB</sub> = 9V, I <sub>C</sub> = 0  | -       | -          | 10         | μΑ       |
| h <sub>FE1</sub><br>h <sub>FE2</sub> | DC Current Gain                      | $V_{CE}$ =1V, $I_{C}$ =0.8A<br>$V_{CE}$ =1V, $I_{C}$ =2A                                    | 22<br>8 | -          | -          |          |
| V <sub>CE</sub> (sat)                | Collector-Emitter Saturation Voltage | I <sub>C</sub> =0.8A, I <sub>B</sub> =0.08A<br>I <sub>C</sub> =2A, I <sub>B</sub> =0.4A     | -       | -          | 0.4<br>0.5 | V<br>V   |
| V <sub>BE</sub> (sat)                | Base-Emitter Saturation Voltage      | I <sub>C</sub> =0.8A, I <sub>B</sub> =0.08A<br>I <sub>C</sub> =2A, I <sub>B</sub> =0.4A     | -       | -          | 1.0<br>1.0 | V<br>V   |
| C <sub>ob</sub>                      | Output Capacitance                   | V <sub>CB</sub> =10V, f=1MHz  | -       | -          | 75         | pF       |
| t <sub>ON</sub>                      | Turn On Time                         | V <sub>CC</sub> =300V, I <sub>C</sub> =2A,  | -       | -          | 150        | ns       |
| t <sub>STG</sub>                     | Storage Time                         | I <sub>B1</sub> =0.4A, I <sub>B2</sub> =-1A,  | -       | -          | 2          | μS       |
| t <sub>F</sub>                       | Fall Time                            | $R_L=150\Omega$   | -       | -          | 0.2        | μS       |
| t <sub>STG</sub>                     | Storage Time                         | V <sub>CC</sub> =15V, V <sub>Z</sub> =300V,   | -       | -          | 2.25       | μS       |
| t <sub>F</sub>                       | Fall Time                            | I <sub>C</sub> =2A, I <sub>B1</sub> =0.4A,<br>I <sub>B2</sub> =-0.4A, L <sub>C</sub> =200μH | -       | -          | 150        | ns       |
| V <sub>F</sub>                       | Diode Forward Voltage                | I <sub>F</sub> =1A<br>I <sub>F</sub> =2A  | -       | -          | 1.5<br>1.6 | V<br>V   |
| t <sub>rr</sub>                      | * Reverse recovery time              | I <sub>F</sub> =0.4A<br>I <sub>F</sub> =1A  | -       | 800        | -          | ns       |
|                                      | $(di/dt = 10A/\mu s)$                |   | -       | 1.4<br>1.9 | -          | μS<br>μS |

<sup>\*</sup> Pulse Test : Pulse Width = 5mS, Duty cycles \le 10%

# **Typical Characteristics**

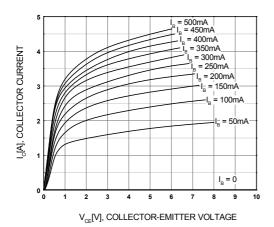
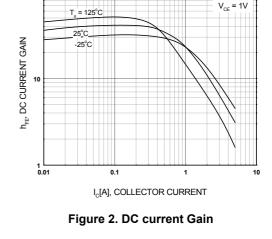


Figure 1. Static Characteristic



100

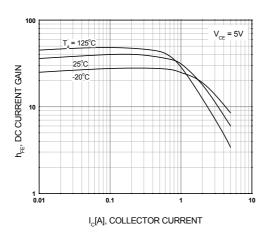


Figure 3. DC current Gain

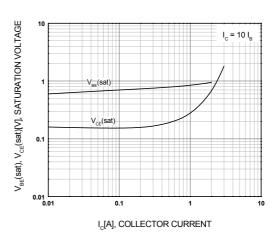


Figure 4. Collector-Emitter Saturation Voltage Base-Emitter Saturation Voltage

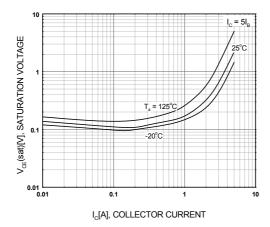


Figure 5. Collector-Emitter Saturation Voltage

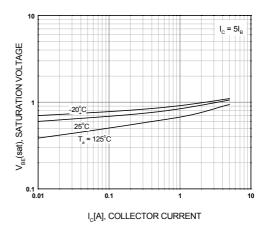


Figure 6. Base-Emitter Saturation Voltage

### Typical Characteristics (Continued)

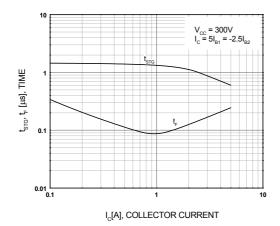


Figure 7. Switching Time

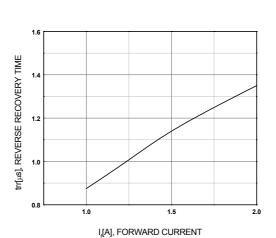


Figure 9. Reverse Recovery Time

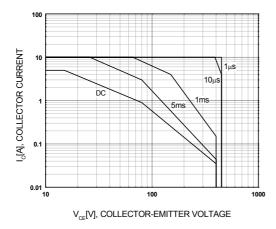


Figure 11. Safe Operating Area

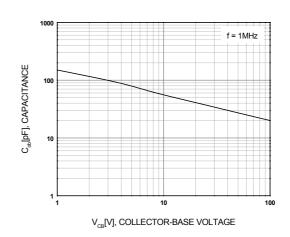


Figure 8. Collector Output Capacitance

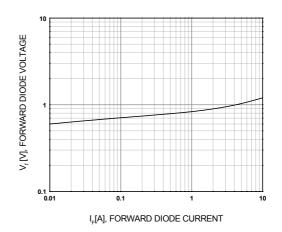


Figure 10. Forward Diode Voltage

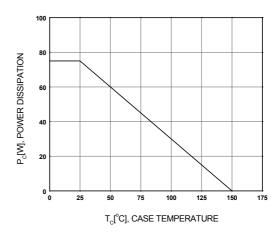


Figure 12. Power Derating

## Typical Characteristics (Continued)

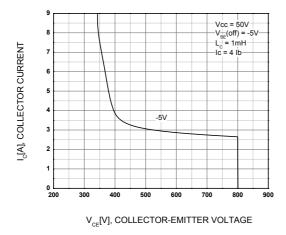


Figure 13. Reverse Bias Safe Operating

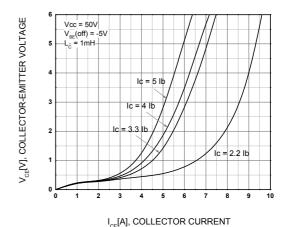
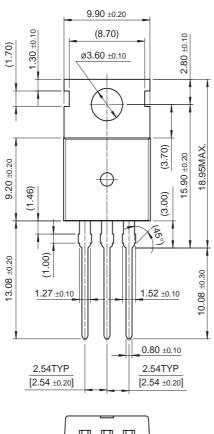
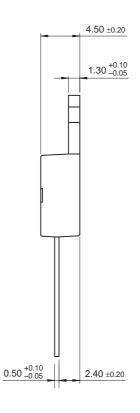


Figure 14. RBSOA Saturation

# **Physical Dimensions**

# TO-220





10.00 ±0.20





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